

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Application of:

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|-------------------------------------|---|------------------------|
| | : | Examiner: S.J. Cohen |
| Hans-Jurgen Albrecht, et al. |) | |
| | : | Group Art No.: 1793 |
| Application No.: 10/554,274 |) | |
| | : | Confirmation No.: 3094 |
| Filed: September 13, 2006 |) | |
| | : | |
| For: SOLDERING MATERIAL BASED ON Sn |) | |
| Ag AND Cu | : | October 5, 2009 |

Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

AMENDMENT

Sir:

In response to the Office Action mailed June 4, 2009,
a response to which having been extended for a period of time of
one (1) month by the accompanying Petition Under 37 C.F.R. §
1.136(a) and fee, kindly amend the subject application as
follows.

Amendments to the claims begin on page 2 of this
paper.

Remarks begin on page 4 of this paper.